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Nanotube Boiler: Attogram Copper Evaporation Driven by Electric Current, Joule Heating, Charge, and Ionization

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Abstract— Controlled copper evaporation at attogram level from individual carbon nanotube (CNT) vessels, which we call nanotube boilers, is investigated experimentally and theoretically. We compared the evaporation modes induced by electric current, Joule heating, charge, and ionization in these CNT boilers, which can serve as sources for mass transport and deposition in nanofluidic systems. Experiments and molecular dynamics simulations show that the most effective method for evaporation is by positively ionizing the encapsulated copper, therefore, an electrostatic field can be used to guide the flow.

Index Terms— Carbon nanotube, transmission electron microscope, nanofluidics, nanoboiler, nanorobotic manipulation

I. INTRODUCTION

CONTROLLED melting and flowing of mass within and between nanochannels is of great interest both fundamentally and from an application perspective[1-8]. We report an experimental and theoretical investigation into attogram copper evaporation from individual carbon nanotubes

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(CNTs), which is motivated by the need to understand the mechanism of this phenomenon. Copper has played a significant role in the history of civilization. In modern semiconductor industry, copper is increasingly replacing aluminum because of its superior electrical conductivity. Growing interest in using it as electrodes and functional elements for the next generation of integrated circuits has been stimulated by the discovery of CNTs, nanowires, and other building blocks, and enabled by bottom-up nanotechnologies such as self-assembly [9], robotic assembly [10], and welding [6, 11]. With the possibility of delivering attogram copper from conduits [6, 7], copper-filled CNTs [12] are an ideal combination for self-welding of self-assembled nanotubes [9] onto electrodes, among other potential nanofluidic applications [13-15].

Previous experimental investigations of controlled melting and flowing of single crystalline copper from individual CNTs [6, 7] have shown that very low current induces melting and drives the flow, which is much more efficient than irradiation-based techniques involving high energy electron beams[16-19], focused-ion beams (FIB) [20], or lasers[14]. Furthermore, conservation of the material is facilitated by its encapsulation as opposed to conveying mass on the external surface of nanotubes [21]. Because both the rate and direction of mass transport depend on the external electrical drive, precise control and delivery of minute amounts of material is possible. However, due to the coupling of the electronic and thermal effects, the mechanisms have not been well understood.

II. SYSTEM SETUP

To understand the mechanisms induced by various physical effects, experimental investigations have been done using the setup shown in Fig. 1, where two Cu-filled CNTs supported on a common sample holder and a probe provide four different experimental modes: (1) The upper section of the left nanotube, CNT_{1,A}, has electric current passing through and accordingly Joule heating will occur. (2) The lower section of the left nanotube, CNT_{1,B}, has no current and will experience only thermal transport. In (3) and (4), the right tube, CNT₂, has no electric current but can be either negatively charged or

Fig. 1. Schematic setup of a nanotube boiler. Two Cu-filled CNTs supported on a sample holder and a probe provide three different cases to investigate, $CNT_{1,A}$, $CNT_{1,B}$, and CNT_2 , subjected to electric current, thermal transport, and charges, respectively.

positively ionized. Thermal transport also occurs from the common sample holder, but not as directly as $CNT_{1,B}$ due to CNTs superior heat conduction ability (Thermal conductivity: $3320 \text{ W/m}\cdot\text{K}$; c.f. Ag: $429 \text{ W/m}\cdot\text{K}$, Cu: $386 \text{ W/m}\cdot\text{K}$, Au: $318 \text{ W/m}\cdot\text{K}$) [22].

The samples we use are Cu-filled CNTs. As described elsewhere, the Cu-tipped CNT samples are synthesized using an alkali doped Cu catalyst by a thermal chemical vapor deposition (CVD) method [12]. The CNTs are up to $5 \mu\text{m}$ long

Fig. 2. Electric current and Joule heating driven Cu evaporation. A series of TEM images recorded the transport of Cu inside two single CNTs when the probe is positively biased (7V). It can be seen that the length of the copper core inside the CNT on the left side continuously decreases.

Fig. 3. Thermal transport and positive charges induced Cu evaporation. A series of TEM images recorded the transport of Cu inside two single CNTs when the probe is negatively biased (-3.5V). It can be seen that the length of the copper core inside the CNT on the left side also continuously decreases.

with outer diameters in a range of $40\text{--}80 \text{ nm}$. The single crystalline Cu nanoneedles are encapsulated in graphite walls approximately 4 to 6 nm thick at the tips of CNTs. The graphite layers are not parallel to the tube axis.

III. EXPERIMENTS

Our experiments were performed in a Philips CM30 transmission electron microscope (TEM) equipped with a scanning tunneling microscope (STM) built in a TEM holder (Nanofactory Instruments AB, ST-1000) serving as a manipulator [2, 6, 23]. The material consisting of a CNT bundle is attached to a 0.35mm thick Au wire using silver paint, and the wire is held in the sample holder (Fig. 1). An etched $10 \mu\text{m}$ thick tungsten wire with a tip radius of approximately 100nm (Picoprobe, T-4-10-1mm) is used as the probe. The probe can be positioned in a millimeter-scale workspace with sub-nanometer resolution with the STM unit actuated by a three-degree-of-freedom piezo-tube, making it possible to select a specific CNT and pick it up. Physical contact can be made between the probe and the tip of a nanotube or between two nanotubes. Applying a voltage between the probe and the sample holder establishes an electrical circuit through a CNT and injects thermal energy into the system via Joule heating. By increasing the applied voltage, the local temperature can be increased past the melting point of the material encapsulated in a tube. The process is recorded by TEM images, a multimeter, and a nA meter. The acceleration voltage used in all experiments was 300kV , the spot size of the electron beam was 100 nm , and the beam current density is in the range of regular imaging, i.e., about $1\text{--}2 \text{ A/cm}^2$. This ensured that the beam does not have obvious influence on the evaporation.

Figure 2 includes a series of TEM images recording the evaporation of Cu driven by current and Joule heating inside two single CNTs when the probe is positively biased (7V). Both of the CNTs have caps on their two ends. It can be seen that the

Fig. 4. (a) and (b) are I-V curves before the threshold on positive and negative biases is reached. It can be seen by comparing (a) and (b) that conductance improved after copper transport (the minimum resistance changed from (a) 377 k Ω to (b) 40 k Ω). (c) Mass evaporation rate.

length of the copper core inside the CNT on the left side (both CNT_{1,A} and CNT_{1,B}) decreases continuously. Figure 3 is a series of TEM images recording the transport of Cu inside two single CNTs when the probe is negatively biased (-3.5V). It can be seen that the length of the copper core inside the CNT on the left side (CNT_{1,B}) also decreases continuously. Because the copper core is not between the electrodes, the polarity of the electrodes does not matter, copper will transport towards one of them.

Surprisingly, it can be seen from Fig. 3 that the length of the copper core inside the CNT on the right side (CNT₂) also decreases continuously until almost all copper disappears. A closer inspection of the insets of Fig. 2 reveals the same phenomena occurred when the probe is positively biased. This implies the possibility that charge induced transport is more significant than current-induced Joule heating and thermal transport. The obvious difference of the evaporation rate for Cu inside CNT₂ suggests that as the Cu is positively ionized (Fig. 3), the repulsive forces between Cu ions are larger than negatively charged case (Fig. 2).

Figure 4(a) and (b) are I-V curves before the positive and negative threshold biases are reached. It can be seen by comparing Fig. 4(a) and (b) that the conductance improved after the copper was transported (the minimum resistance changed from Fig. 4(a) 377 k Ω to Fig. 4(b) 40 k Ω). This suggests copper deposited on the probe in the case of Fig. 4(a) changed the contact from a Schottky-type to Ohmic. The decrease of resistance from 477 k Ω (-6.5 V) to 377 k Ω (6.5 V)

Fig. 5. Molecular dynamics simulation of Joule-heating and ionization-induced. (a) Evaporation induced by Joule-heating. The diffusion of copper atoms inside the carbon shells can obviously be seen from the inset including the initial configuration and frames 10, 20, 30, and 40. (b) The electrostatic repulsive energy between copper ions. The inset shows carbon-carbon bond length during copper diffusion. At frame 200 the copper ions pass through the hexagonal rings, which correspond to the maximum opening of the carbon rings.

in the case of Fig. 4(a) indicates the transport/deposition on the probe occurred during the bias sweeps from -6.5 V to 6.5V.

Figure 4(c) indicates the estimated mass evaporation rate according to the apparent geometries shown in Figs. 1 and 2 and the density of copper (8.92 g/cm³). Using linear fitting, the average mass evaporation rate has been found to be 14.3 ag/s and 1.2 ag/s for CNT_{1,B} as the probe is positively (Fig. 2) and negatively (Fig. 3) biased, respectively. The difference (approximately 12 times) between the rates of CNT_{1,B} is due to the competition between electrostatic forces and Joule heating induced evaporation. The latter is mainly caused by the different absolute values of the bias V (7V and -3.5V) and the resistance R (377 k Ω to 40 k Ω). Considering that thermal power scales with V^2/R , the bias differences translate into a factor of 2.4, but the evaporation rate as the probe is negatively biased should be larger. This is contrary to the experimental

observation. Hence, it can be concluded that electrostatic forces dominate evaporation. The growing distance from the heated section also has contribution but less due to the excellent thermal conductivity of CNTs.

Similarly, using linear fitting, the average mass evaporation rate has been found to be 0.1 ag/s and 6.1 ag/s for CNT₂ as the probe is positively (Fig. 2) and negatively biased (Fig. 3), respectively. This suggests that when Cu is ionized, the repulsive interaction between Cu⁺ is much larger than electron charges.

IV. SIMULATIONS

Using molecular dynamics simulation (MDS), we numerically investigated pure Joule-heating and ionization-induced Cu evaporation (Fig. 5). The potential energy of a CNT with a cluster of Cu inside was minimized at an internal pressure of 1 atm using the conjugate gradient method. To investigate copper diffusion, the system was simulated at temperatures between 700K and 1800K using molecular dynamics. Figure 5 (a) shows the system temperature during evaporation induced by Joule-heating when the carbon shells are electrically neutral. The diffusion of copper atoms inside the carbon shells can obviously be seen from the inset including the initial configuration and frames 10, 20, 30, and 40. An analysis of the repulsive electrostatic energy between copper ions is given in Fig. 5(b). It can be seen that a peak temperature was reached at frame 200. Accordingly, as shown in the inset, the carbon-carbon bond length obtained a maximum value at frame 200. The simulation indicates that electrostatic energy is responsible for heating, and that the repulsive charges increase the distances between copper ions and induce their diffusion with higher energy. It can be seen from the inset of Fig. 5(b) that with a large enough charge, copper ions can pass through the walls of CNTs without necessarily breaking the bonds. Images clearly show that the hexagon carbon rings stretch during diffusion.

V. SUMMARY

In summary, we have reported an experimental and theoretical investigation into attogram copper evaporation from individual CNTs for four modes induced by electric current, Joule heating, charges, and ionization. The experimental setup allowed the decoupling of the modes from each other. Experiments and molecular dynamics simulations have shown that the most effective way for evaporation is by positively ionizing the encapsulated copper, which indicate that the repulsive electrostatic energy between copper ions dominate thermal energy. The proposed CNT boilers can serve as sources for mass transport and deposition in nanofluidic systems using electrostatic fields to guide the flow.

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